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Octal buffer/line driver; 3-state

Rev. 1 — 9 July 2012

Product data sheet

1. General description

The 74AHC244-Q100; 74AHCT244-Q100 is a high-speed Si-gate CMOS device.

The 74AHC244-Q100; 74AHCT244-Q100 has octal non-inverting buffer/line drivers with 3-state outputs. The 3-state outputs are controlled by the output enable inputs ($n\overline{OE}$). A HIGH on nOE causes the outputs to assume a high-impedance OFF-state.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Balanced propagation delays
- All inputs have a Schmitt trigger action
- Inputs accept voltages higher than V_{CC}
- For 74AHC244-Q100 only: operates with CMOS input levels
- For 74AHCT244-Q100 only: operates with TTL input levels
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- Multiple package options

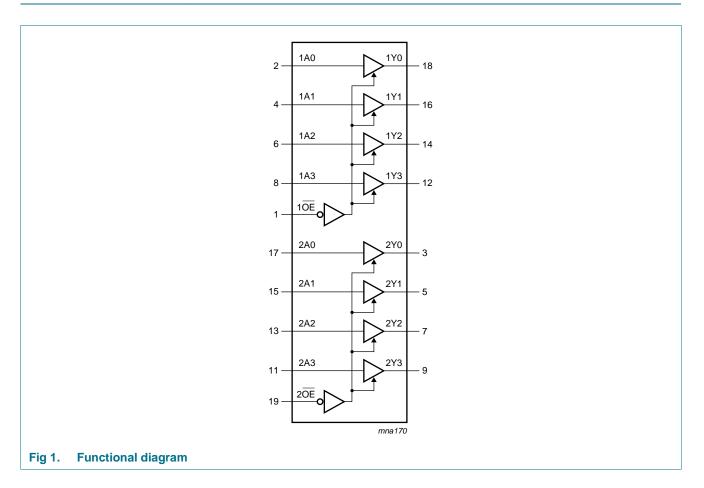


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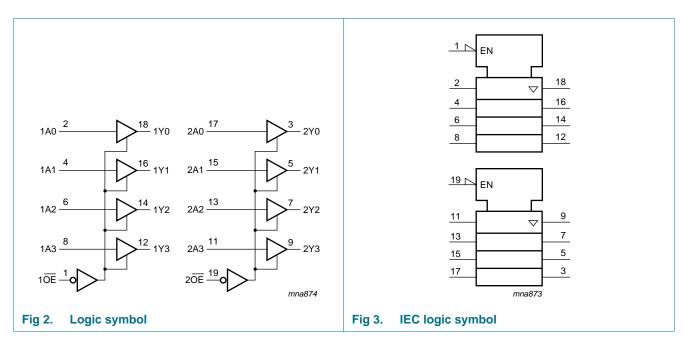
3. Ordering information

| Table 1.Ordering inType number | Package | | | | |
|--------------------------------|-------------------|----------|---|------------|--|
| | Temperature range | Name | Description | Version | |
| 74AHC244D-Q100 | –40 °C to +125 °C | SO20 | plastic small outline package; 20 leads; | SOT163-1 | |
| 74AHCT244D-Q100 | | | body width 7.5 mm | | |
| 74AHC244PW-Q100 | –40 °C to +125 °C | TSSOP20 | plastic thin shrink small outline package; 20 leads; | ; SOT360-1 | |
| 74AHCT244PW-Q100 | | | body width 4.4 mm | | |
| 74AHC244BQ-Q100 | –40 °C to +125 °C | DHVQFN20 | plastic dual-in-line compatible thermal enhanced | SOT764-1 | |
| 74AHCT244BQ-Q100 | | | very thin quad flat package; no leads; 20 terminals; body 2.5 \times 4.5 \times 0.85 mm | | |

4. Functional diagram

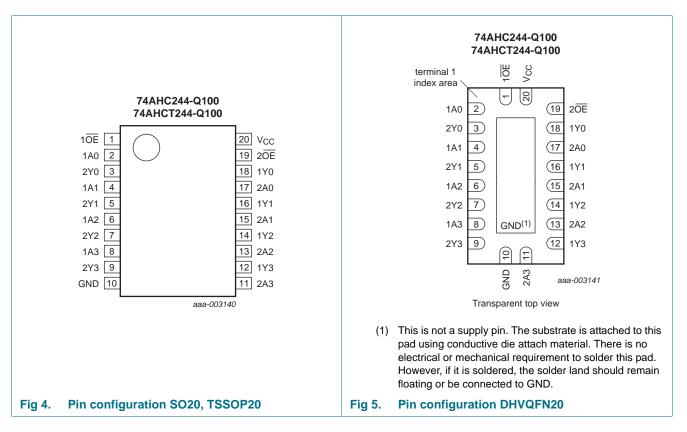


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5. Pinning information

5.1 Pinning



NXP Semiconductors

74AHC244-Q100; 74AHCT244-Q100

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5.2 Pin description

| Table 2. | Pin description | |
|-----------------|-----------------|----------------------------------|
| Symbol | Pin | Description |
| 10E, 20E | 1, 19 | output enable input (active LOW) |
| 1A[0:3] | 2, 4, 6, 8 | data input |
| 2A[0:3] | 17, 15, 13, 11 | data input |
| 1Y[0:3] | 18, 16, 14, 12 | data output |
| 2Y[0:3] | 3, 5, 7, 9 | data output |
| GND | 10 | ground (0 V) |
| V _{CC} | 20 | supply voltage |
| | | |

6. Functional description

Table 3. Function table^[1]

| Control | Input | Output |
|-------------------|-------|--------|
| n <mark>OE</mark> | nAn | nYn |
| L | L | L |
| | Н | Н |
| Н | Х | Z |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| | | | | 10 | , |
|------------------|-------------------------|--|----------------|------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| V _{CC} | supply voltage | | -0.5 | +7.0 | V |
| VI | input voltage | | -0.5 | +7.0 | V |
| I _{IK} | input clamping current | V _I < -0.5 V | <u>[1]</u> –20 | - | mA |
| I _{OK} | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V | <u>[1]</u> _ | ±20 | mA |
| lo | output current | V_{O} = -0.5 V to (V _{CC} + 0.5 V) | - | ±25 | mA |
| I _{CC} | supply current | | - | 75 | mA |
| I _{GND} | ground current | | -75 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$ | | | |
| | SO20 package | | [2] _ | 500 | mW |
| | TSSOP20 package | | [3] _ | 500 | mW |
| | DHVQFN20 package | | <u>[4]</u> _ | 500 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] P_{tot} derates linearly with 8 mW/K above 70 °C.

[3] P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[4] Ptot derates linearly with 4.5 mW/K above 60 °C.

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Product data sheet

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Recommended operating conditions 8.

Recommended operating conditions Table 5.

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | 74AH | C244-Q1 | 00 | 74AH0 | 74AHCT244-Q100 | | |
|---|---------------------|------------------------------|------|---------|-----------------|-------|----------------|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 5.5 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | 0 | - | 5.5 | V |
| Vo | output voltage | | 0 | - | V _{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |
| $\Delta t/\Delta V$ input transition rise | | V_{CC} = 3.3 V \pm 0.3 V | - | - | 100 | - | - | - | ns/V |
| | and fall rate | $V_{CC}=5.0~V\pm0.5~V$ | - | - | 20 | - | - | 20 | ns/V |

Static characteristics 9.

Static characteristics Table 6.

Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | 25 °C | | –40 °C to +85 °C | | –40 °C to +125 °C | | Unit |
|-----------------|-----------------------------|--|---------------|--------------|------------------|------------------|------|-------------------|-----------------------|-------------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74AHC2 | 44-Q100 | | | | | | | | | |
| V _{IH} | HIGH-level | V _{CC} = 2.0 V | 1.5 | - | - | 1.5 | - | 1.5 | - | V |
| | input voltage | V _{CC} = 3.0 V | 2.1 | - | - | 2.1 | - | 2.1 | - | V |
| | | V _{CC} = 5.5 V | 3.85 | - | - | 3.85 | - | 3.85 | - | V |
| V _{IL} | LOW-level | V _{CC} = 2.0 V | - | - | 0.5 | - | 0.5 | - | 0.5 | V |
| | input voltage | V _{CC} = 3.0 V | - | - | 0.9 | - | 0.9 | - | 0.9 | V |
| | V _{CC} = 5.5 V | - | - | 1.65 | - | 1.65 | - | 1.65 | V | |
| V _{OH} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | $I_{O} = -50 \ \mu A; \ V_{CC} = 3.0 \ V$ | 2.9 | 3.0 | - | 2.9 | - | 2.9 | - | V |
| | | $I_{O} = -50 \ \mu A; \ V_{CC} = 4.5 \ V$ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.58 | - | - | 2.48 | - | 2.40 | - | V |
| | | $I_{O} = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.94 | - | - | 3.8 | - | 3.70 | - | V |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | | |
| | output voltage | $I_0 = 50 \ \mu A; \ V_{CC} = 2.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 50 \ \mu A; \ V_{CC} = 3.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 50 \ \mu A; V_{CC} = 4.5 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| | | I_0 = 8.0 mA; V_{CC} = 4.5 V | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I _{OZ} | OFF-state output current | | - | - | ±0.25 | - | ±2.5 | - | ±10.0 | μΑ |
| I | input leakage current | V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | - | - | 0.1 | - | 1.0 | - | 2.0 | μΑ |
| I _{CC} | supply current | | - | - | 4.0 | - | 40 | - | 80 | μA |
| 74AHC_AHCT24 | 44_Q100 | All information provided | in this docum | ent is subje | ct to legal disc | laimers. | | © N | (P B.V. 2012. All rig | hts reserve |
| 74AHC_AHCT24 | 44_Q100 | All information provided | in this docum | | - | laimers. | | © N | (P B.V. 2012. All ri | g |

Octal buffer/line driver; 3-state

| Symbol | Parameter | Conditions | | 25 °C | | _40 °C | to +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|-----------------------------|---|-----|-------|-------|--------|-----------|----------|-----------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| Cı | input capacitance | | - | 3.0 | 10 | - | 10 | - | 10 | pF |
| Co | output capacitance | | - | 4.0 | - | - | - | - | - | pF |
| 74AHCT | 244-Q100 | | | | | | | | | |
| V _{IH} | HIGH-level input voltage | V_{CC} = 4.5 V to 5.5 V | 2.0 | - | - | 2.0 | - | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | V_{CC} = 4.5 V to 5.5 V | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| V _{OH} | HIGH-level | V_{I} = V_{IH} or $V_{IL};V_{CC}$ = 4.5 V | | | | | | | | |
| output voltage | | I _O = -50 μA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | I _O = -8.0 mA | 3.94 | - | - | 3.8 | - | 3.70 | - | V | |
| 01 | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$ | | | | | | | | |
| | output voltage | I _O = 50 μA | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | l _O = 8.0 mA | - | - | 0.36 | - | 0.44 | - | 0.55 | V |
| I _{OZ} | OFF-state output current | per input pin; V _I = V _{IH} or V _{IL} ; V _{CC} = 5.5 V; I _O = 0 A | - | - | ±0.25 | - | ±2.5 | - | ±10.0 | μA |
| | | $V_{O} = V_{CC}$ or GND; other pins at V_{CC} or GND | | | | | | | | |
| lı | input leakage current | $V_I = 5.5 V \text{ or GND};$ $V_{CC} = 0 V \text{ to } 5.5 V$ | - | - | 0.1 | - | 1.0 | - | 2.0 | μΑ |
| I _{CC} | supply current | | - | - | 4.0 | - | 40 | - | 80 | μΑ |
| ΔI _{CC} | additional supply current | per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other pins at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V | - | - | 1.35 | - | 1.5 | - | 1.5 | mA |
| CI | input capacitance | | - | 3 | 10 | - | 10 | - | 10 | pF |
| Co | output capacitance | | - | 4.0 | - | - | - | - | - | pF |

Table 6.Static characteristics ... continuedVoltages are referenced to GND (ground = $0 V_{ch}$)

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10. Dynamic characteristics

Table 7. **Dynamic characteristics**

GND = 0 V. For test circuit see Figure 8.

| Symbol | Parameter | Conditions | | | 25 °C | | −40 °C | to +85 °C | –40 °C t | o +125 °C | Unit |
|------------------|-------------------------------------|--|------------|-----|--------|------|---------------|-----------|----------|-----------|------|
| | | | | Min | Typ[1] | Max | Min | Max | Min | Max | |
| 74AHC2 | 44-Q100 | | | | | | | | | | |
| t _{pd} | propagation | nAn to nYn; see Figure 6 | [2] | | | | | | | | |
| | delay | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 5.0 | 8.4 | 1.0 | 10.0 | 1.0 | 10.5 | ns |
| | | C _L = 50 pF | | - | 7.0 | 11.9 | 1.0 | 13.5 | 1.0 | 15.0 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 3.4 | 5.5 | 1.0 | 6.5 | 1.0 | 7.0 | ns |
| | | C _L = 50 pF | | | 5.0 | 7.5 | 1.0 | 8.5 | 1.0 | 9.5 | ns |
| t _{en} | enable time | nOE to nYn; see Figure 7 | [2] | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 6.5 | 10.6 | 1.0 | 12.5 | 1.0 | 13.5 | ns |
| | | C _L = 50 pF | | - | 7.5 | 14.1 | 1.0 | 16.0 | 1.0 | 18.0 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 4.0 | 7.3 | 1.0 | 8.5 | 1.0 | 9.5 | ns |
| | | C _L = 50 pF | | - | 5.5 | 9.3 | 1.0 | 10.5 | 1.0 | 12.0 | ns |
| t _{dis} | disable time | nOE to nYn; see Figure 7 | [2] | | | | | | | | |
| | | V_{CC} = 3.0 V to 3.6 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 5.5 | 9.7 | 1.0 | 11.0 | 1.0 | 12.5 | ns |
| | | C _L = 50 pF | | - | 10.0 | 14.0 | 1.0 | 16.0 | 1.0 | 17.5 | ns |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 4.8 | 7.2 | 1.0 | 8.5 | 1.0 | 9.0 | ns |
| | | C _L = 50 pF | | - | 7.0 | 9.2 | 1.0 | 10.5 | 1.0 | 11.5 | ns |
| C _{PD} | power dissipation capacitance | $C_L = 50 \text{ pF}; f_i = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | <u>[3]</u> | - | 10 | - | - | - | - | - | pF |

capacitance

Octal buffer/line driver; 3-state

| Symbol | Parameter | Conditions | | 25 °C - | | | -40 °C ⁵ | to +85 °C | –40 °C t | o +125 °C | Unit |
|--------------------|-------------------------------------|---|------------|---------|--------|------|----------|-----------|----------|-----------|------|
| | | | | Min | Typ[1] | Max | Min | Max | Min | Мах | |
| 74AHCT | 244-Q100 | | | | | | 1 | | | | |
| t _{pd} | propagation | nAn to nYn; see Figure 6 | [2] | | | | | | | | |
| | delay | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 3.5 | 7.4 | 1.0 | 8.5 | 1.0 | 9.5 | ns |
| | | C _L = 50 pF | | - | 5.0 | 8.4 | 1.0 | 9.5 | 1.0 | 10.5 | ns |
| t _{en} er | enable time | nOE to nYn; see Figure 7 | | | | | | | | | |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 3.5 | 10.4 | 1.0 | 12.0 | 1.0 | 13.0 | ns |
| | | C _L = 50 pF | | - | 5.5 | 11.4 | 1.0 | 13.0 | 1.0 | 14.5 | ns |
| t _{dis} | disable time | nOE to nYn; see Figure 7 | [2] | | | | | | | | |
| | | V_{CC} = 4.5 V to 5.5 V | | | | | | | | | |
| | | C _L = 15 pF | | - | 5.0 | 9.4 | 1.0 | 10.0 | 1.0 | 12.0 | ns |
| | | C _L = 50 pF | | - | 7.0 | 11.4 | 1.0 | 13.0 | 1.0 | 14.5 | ns |
| C _{PD} | power dissipation capacitance | per buffer; $C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | <u>[3]</u> | - | 12 | - | - | - | - | - | pF |

Table 7. Dynamic characteristics ... continued

[1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V).

 $\label{eq:tpd} [2] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

 t_{en} is the same as t_{PZL} and $t_{\text{PZH}}.$

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

[3] C_{PD} is used to determine the dynamic power dissipation P_D (μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

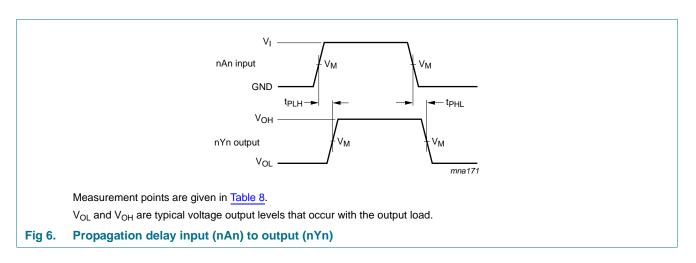
 f_i = input frequency in MHz;

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in Volts.

11. Waveforms



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Product data sheet

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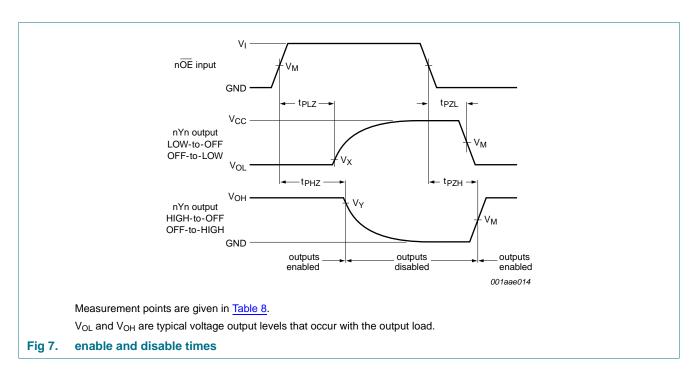


Table 8. Measurement points

| Туре | Input | Output | | | | |
|----------------|--------------------|--------------------|-------------------------|-------------------------|--|--|
| | V _M | V _M | V _X | V _Y | | |
| 74AHC244-Q100 | 0.5V _{CC} | 0.5V _{CC} | V _{OL} + 0.3 V | V _{OH} – 0.3 V | | |
| 74AHCT244-Q100 | 1.5 V | 0.5V _{CC} | V _{OL} + 0.3 V | $V_{OH} - 0.3 \ V$ | | |

Octal buffer/line driver; 3-state

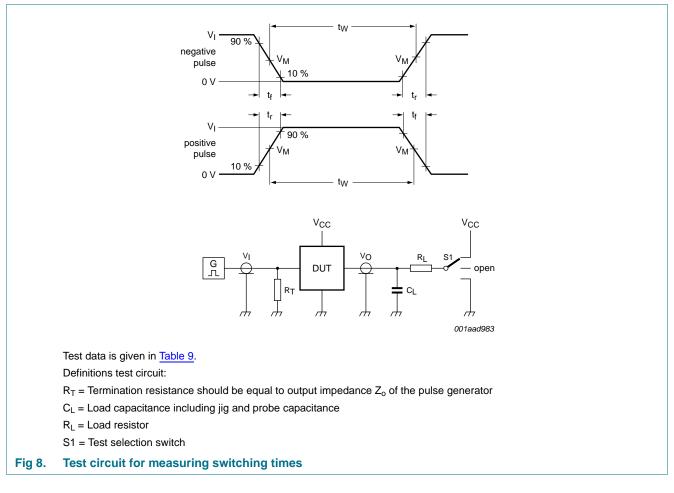


Table 9. Test data

| Туре | Input | | Load | | S1 position | | |
|----------------|-----------------|---------------------------------|--------------|------|-------------------------------------|-------------------------------------|-------------------------------------|
| | VI | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 74AHC244-Q100 | V _{CC} | 3.0 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} |
| 74AHCT244-Q100 | 3.0 V | 3.0 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} |

Octal buffer/line driver; 3-state

12. Package outline

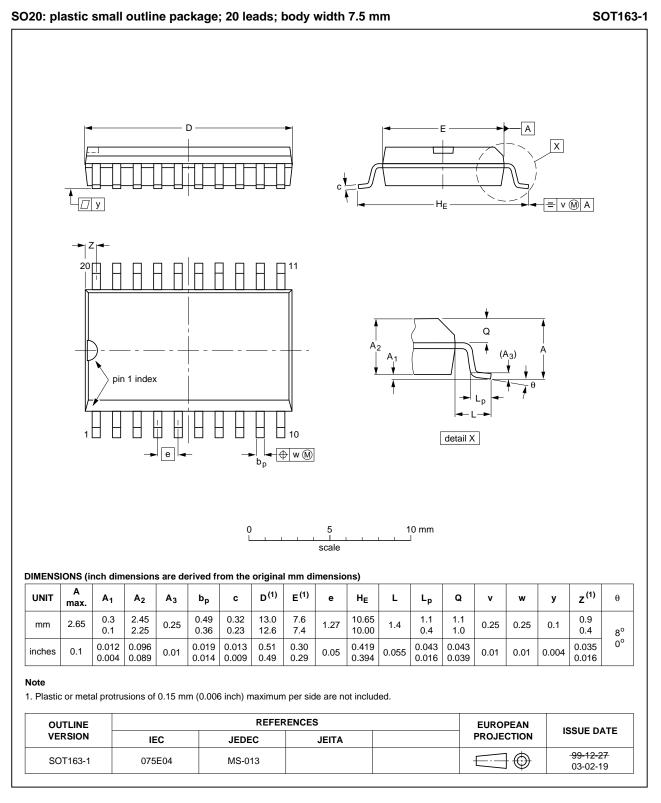


Fig 9. Package outline SOT163-1 (SO20)

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Octal buffer/line driver; 3-state

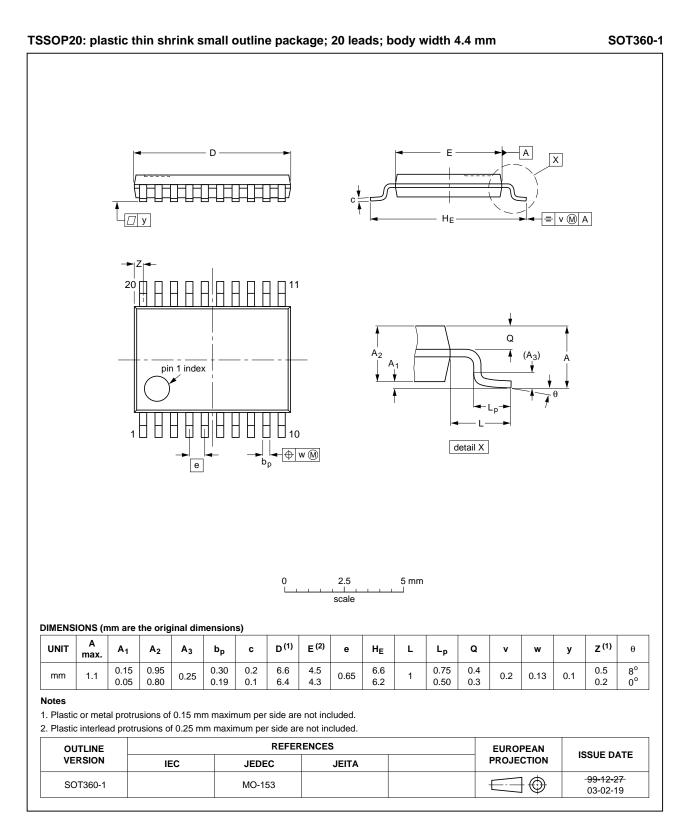
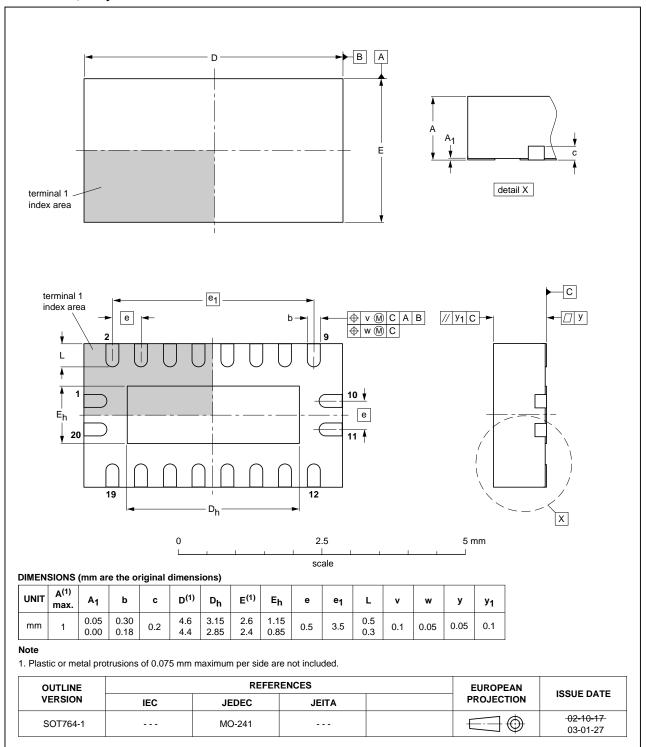


Fig 10. Package outline SOT360-1 (TSSOP20)

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Octal buffer/line driver; 3-state



DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 11. Package outline SOT764-1 (DHVQFN20)

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Octal buffer/line driver; 3-state

13. Abbreviations

| Table 10. | Abbreviations |
|-----------|---|
| Acronym | Description |
| CDM | Charge Device Model |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |
| MIL | Military |
| | |

14. Revision history

| Table 11. Revision history | | | | |
|----------------------------|--------------|--------------------|---------------|------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74AHC_AHCT244_Q100 v.1 | 20120709 | Product data sheet | - | - |

15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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